Taiwan Semiconductor

3A, 100V - 200V Ultra Fast Surface Mount Rectifier

FEATURES

- AEC-Q101 qualified
- Planar technology
- Low power loss, high efficiency
- Ideal for automated placement
- Wettable flank
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- High frequency switching
- DC/DC
- Snubber

MECHANICAL DATA

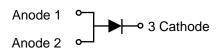
- Case: TO-277A (SMPC4.6U)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.102g (approximately)

| KEY PARAMETERS | | | |
|-----------------------|--|--|--|
| VALUE | UNIT | | |
| 3 | А | | |
| 100 - 200 | V | | |
| 85 | А | | |
| 175 | °C | | |
| TO-277A (SMPC4.6U) | | | |
| Single die | | | |
| | 3 100 - 200 85 175 TO-27 (SMPC4 | | |

HALOGEN



TO-277A (SMPC4.6U)



| ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted) | | | | | |
|---|-----------|---------------------|----------------------------|---------|------|
| PARAMETER | | SYMBOL | PUUP3BH | PUUP3DH | UNIT |
| Marking code on the device | | | PU3BH | PU3DH | |
| Repetitive peak reverse voltage | | V _{RRM} | 100 | 200 | V |
| Reverse voltage, total rms value | | V _{R(RMS)} | 70 | 140 | V |
| Forward current | | ١ _F | 3 | | А |
| Surge peak forward current single half | t = 8.3ms | | I _{FSM} 85 190 | | - A |
| sine-wave superimposed on rated load | t = 1.0ms | IFSM | | | |
| Junction temperature | | TJ | -55 to +175 | | °C |
| Storage temperature | | T _{STG} | -55 to +175 | | °C |



| THERMAL PERFORMANCE | | | |
|---|------------------|------|------|
| PARAMETER | SYMBOL | ТҮР | UNIT |
| Junction-to-lead thermal resistance ⁽¹⁾ | R _{θJL} | 2.0 | °C/W |
| Junction-to-ambient thermal resistance ⁽²⁾ | R _{θJA} | 52.4 | °C/W |
| Junction-to-case thermal resistance ⁽²⁾ | R _{eJC} | 11.4 | °C/W |

Thermal Performance Notes:

1. With ideal heat sink

2. Units mounted on PCB (16mm x 16mm Cu pad test board)

| PARAMETER | CONDITIONS | SYMBOL | ТҮР | MAX | UNIT |
|-------------------------------------|--|-----------------|------|------|------|
| Forward voltage ⁽¹⁾ | I _F = 1.5A, T _J = 25°C | | 0.81 | - | V |
| | $I_F = 3.0A, T_J = 25^{\circ}C$ | N | 0.86 | 0.93 | V |
| | $I_F = 1.5A, T_J = 125^{\circ}C$ | V _F | 0.66 | - | V |
| | $I_F = 3.0A, T_J = 125^{\circ}C$ | | 0.73 | - | V |
| Reverse current @ rated $V_R^{(2)}$ | $T_J = 25^{\circ}C$ | I _R | - | 2 | μA |
| | T _J = 125°C | | - | 10 | μA |
| Junction capacitance | 1MHz, V _R = 4.0V | CJ | 47 | - | pF |
| Reverse recovery time | $I_F = 0.5A, I_R = 1.0A, I_{rr} = 0.25A$ | | - | 25 | ns |
| | $I_F = 1.0A$, di/dt = 50A/µs, $V_R = 30V$ | t _{rr} | 31 | - | |
| Reverse recovery current | | I _{RM} | 4.9 | - | Α |
| Reverse recovery charge | $I_F = 3.0A$, di/dt = 200A/µs, $V_R = 100V$ | Q _{rr} | 51 | - | nC |
| Reverse recovery time |] | t _{rr} | 23 | - | ns |

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION

| ORDERING CODE ⁽¹⁾ | PACKAGE | PACKING |
|------------------------------|--------------------|--------------------|
| PUUP3xH | TO-277A (SMPC4.6U) | 6,000/ Tape & Reel |

Notes:

1. "x" defines voltage from 100V(PUUP3BH) to 200V(PUUP3DH)



f=1.0MHz Vsig=50mVp-p

CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

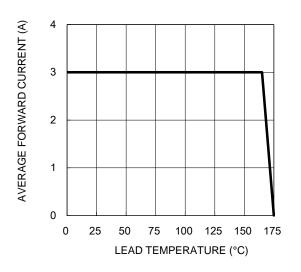
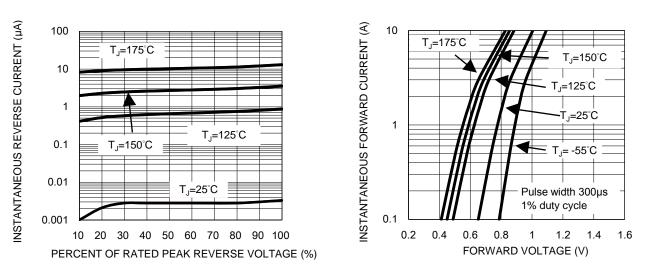


Fig.1 Forward Current Derating Curve

Fig.3 Typical Reverse Characteristics



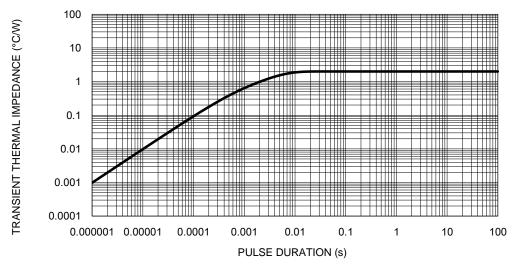


Fig.5 Typical Transient Thermal Impedance

Fig.2 Typical Junction Capacitance

10

Fig.4 Typical Forward Characteristics

REVERSE VOLTAGE (V)

100

1000

100

10

1

CAPACITANCE (pF)

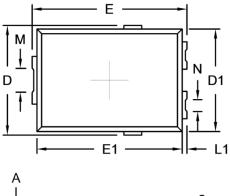
PUUP3BH – PUUP3DH

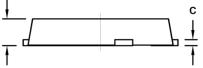
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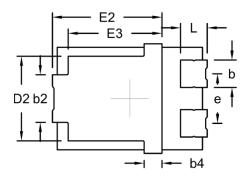


PACKAGE OUTLINE DIMENSIONS

TO-277A (SMPC4.6U)







SUGGESTED PAD LAYOUT

В

D

F

1

С

1

| DIM. | Unit (mm) | | Unit (| (inch) |
|------|-------------|-------|--------|--------|
| | Min. | Max. | Min. | Max. |
| A | 1.00 | 1.20 | 0.039 | 0.047 |
| b | 1.05 | 1.35 | 0.041 | 0.053 |
| b2 | 1.90 | 2.20 | 0.075 | 0.087 |
| b4 | 0.75 (| NOM.) | 0.030 | (NOM.) |
| с | 0.15 | 0.40 | 0.006 | 0.016 |
| D | 4.45 | 4.75 | 0.175 | 0.187 |
| D1 | 4.25 | 4.35 | 0.167 | 0.171 |
| D2 | 3.40 | 3.70 | 0.134 | 0.146 |
| E | 6.35 | 6.65 | 0.250 | 0.262 |
| E1 | 6.05 | 6.15 | 0.238 | 0.242 |
| E2 | 4.40 | 4.80 | 0.173 | 0.189 |
| E3 | 3.94 (NOM.) | | 0.155 | (NOM.) |
| е | 2.08 (NOM.) | | 0.082 | (NOM.) |
| L | 0.94 | 1.24 | 0.037 | 0.049 |
| L1 | 0.05 | 0.35 | 0.002 | 0.014 |
| М | 0.65 | 1.15 | 0.026 | 0.045 |
| N | 0.25 | 0.75 | 0.010 | 0.030 |

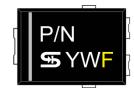
Package body size D1 and E1 do not include mold flash Mold flash shall not exceed 0.1mm per side

| Symbol | Unit (mm) | Unit (inch) |
|--------|-----------|-------------|
| A | 4.95 | 0.195 |
| В | 4.95 | 0.195 |
| С | 1.60 | 0.063 |
| D | 1.42 | 0.056 |
| E | 6.95 | 0.274 |
| F | 1.04 | 0.041 |

MARKING DIAGRAM

A

1



- E ·

| P/N | = Marking Code |
|-----|----------------|
| YW | = Date Code |
| F | = Factory Code |



PUUP3BH – PUUP3DH

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